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(12) **United States Design Patent**  
**Hwang**

(10) **Patent No.:** **US D468,698 S**

(45) **Date of Patent:** **\*\* \*Jan. 14, 2003**

(54) **CASING FOR OPTICAL TRANSCEIVER MODULE**

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(73) **Assignee:** **Hon Hai Precision Ind. Co. Ltd, Taipei Hsien (TW)**

(\*) **Notice:** This patent is subject to a terminal disclaimer.

(\*\*) **Term:** **14 Years**

(21) **Appl. No.:** **29/150,456**

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(51) **LOC (7) Cl. .... 13-03**

(52) **U.S. Cl. .... D13/154**

(58) **Field of Search** ..... D13/133, 152, D13/154, 184, 199; D10/80, 103; 174/50.52, 50.54, 52.1, 53; 206/721, 722, 724; 361/679, 724, 752, 816, 821; 439/76.1, 567, 609, 651; 455/300

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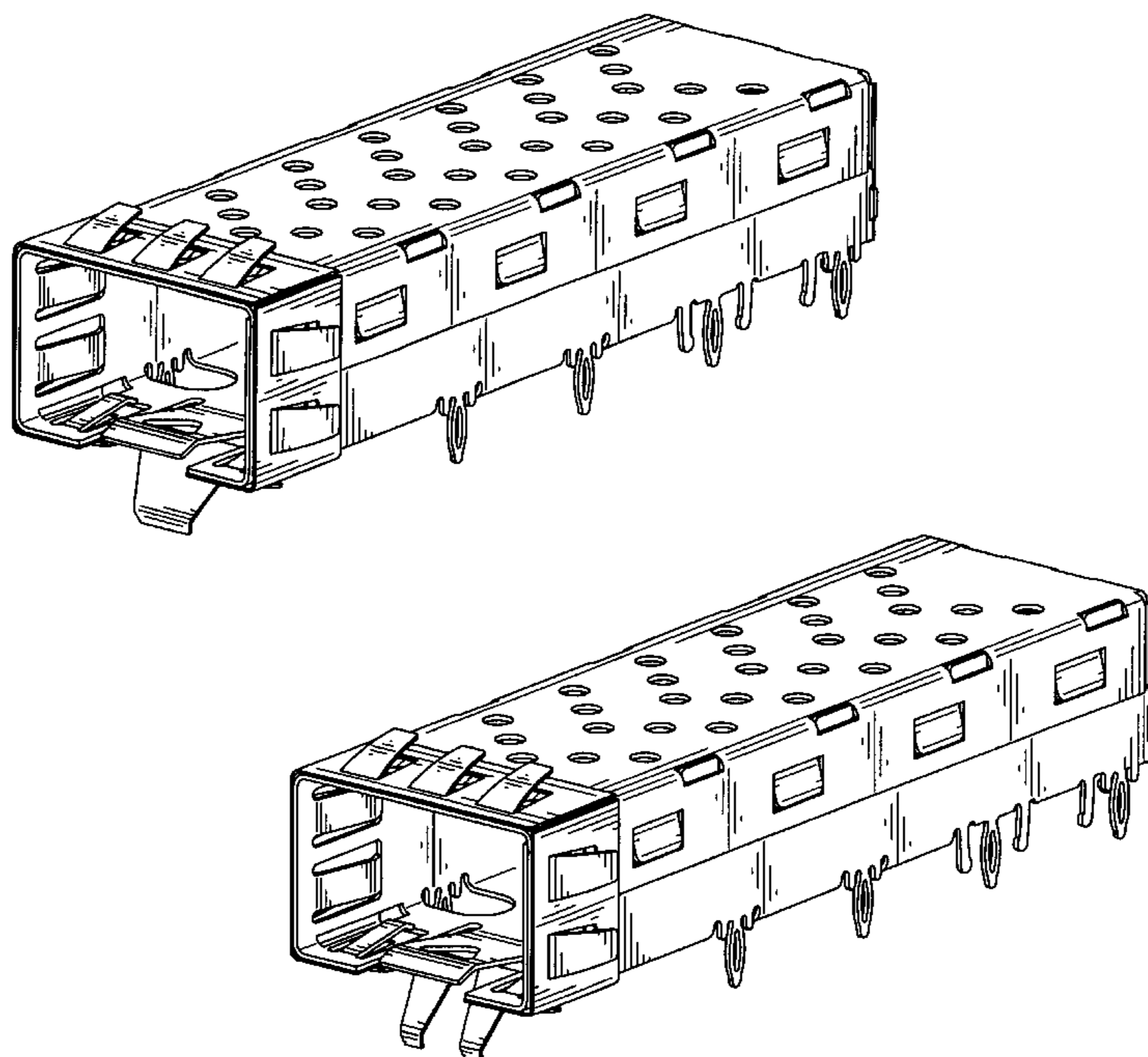
(57) **CLAIM**

The ornamental design for a casing for optical transceiver module, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a casing for optical transceiver module showing a preferred embodiment of my new design;  
 FIG. 2 is a front view of FIG. 1;  
 FIG. 3 is a rear view of FIG. 1;  
 FIG. 4 is a left side elevational view of FIG. 1;  
 FIG. 5 is a right side elevational view of FIG. 1;  
 FIG. 6 is a top plan view of FIG. 1;  
 FIG. 7 is a bottom plan view of FIG. 1;  
 FIG. 8 is a perspective view of a casing for optical transceiver module showing an alternative embodiment of my new design;  
 FIG. 9 is a front view of FIG. 8;  
 FIG. 10 is a rear view of FIG. 8;  
 FIG. 11 is a left side elevational view of FIG. 8;  
 FIG. 12 is a right side elevational view of FIG. 8;  
 FIG. 13 is a top plan view of FIG. 8; and,  
 FIG. 14 is a bottom plan view of FIG. 8.

**1 Claim, 10 Drawing Sheets**



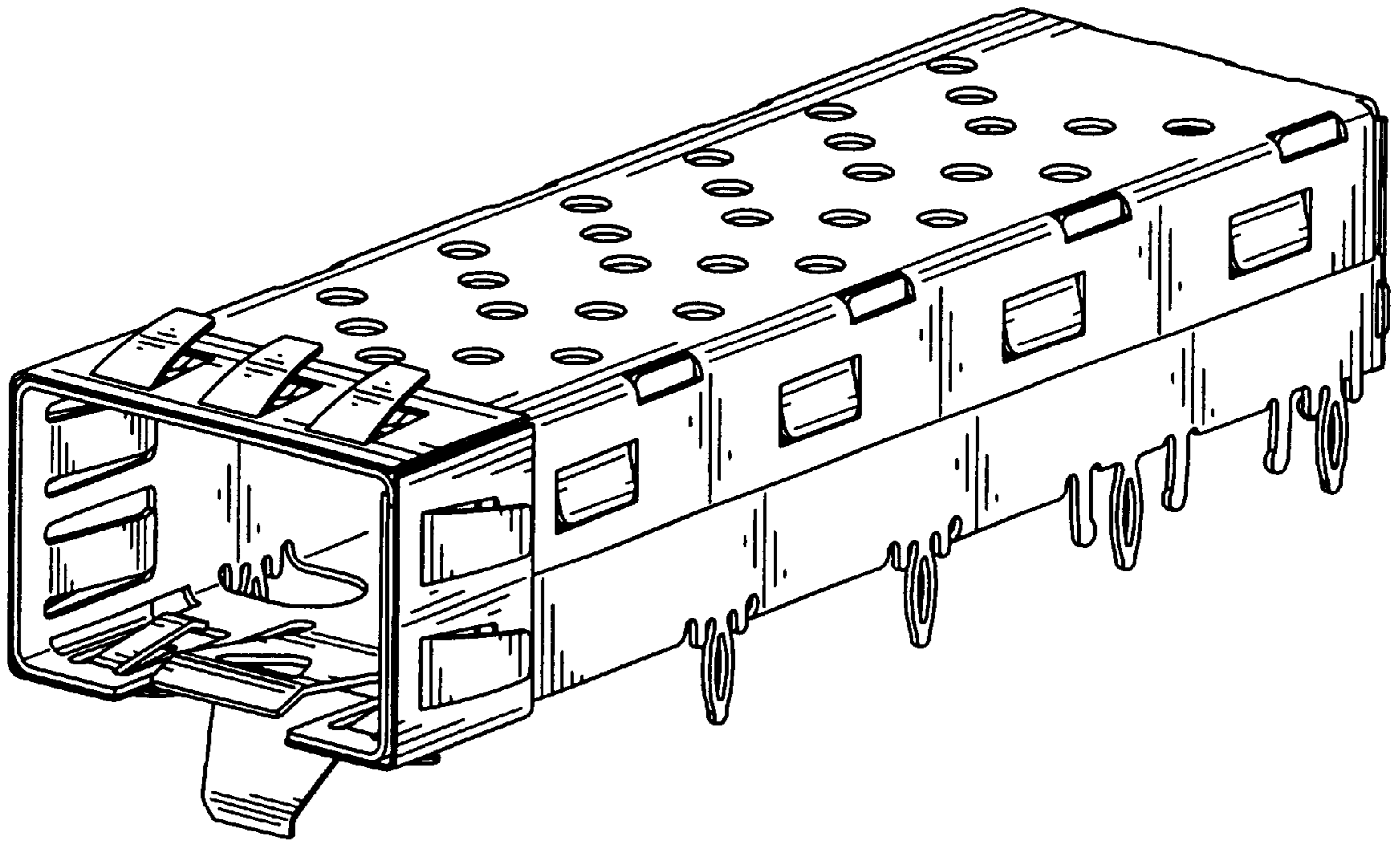


FIG. 1

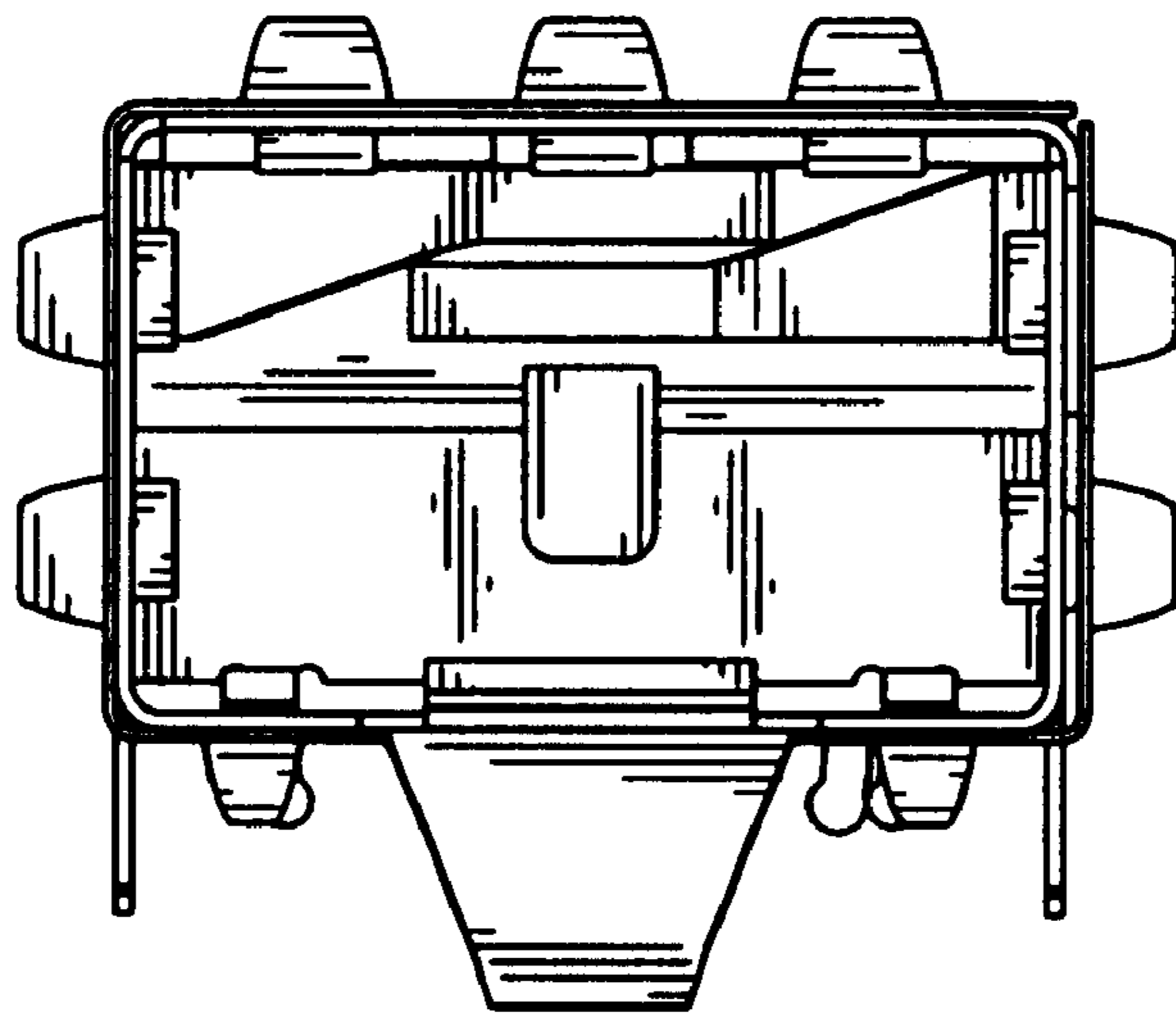


FIG. 2

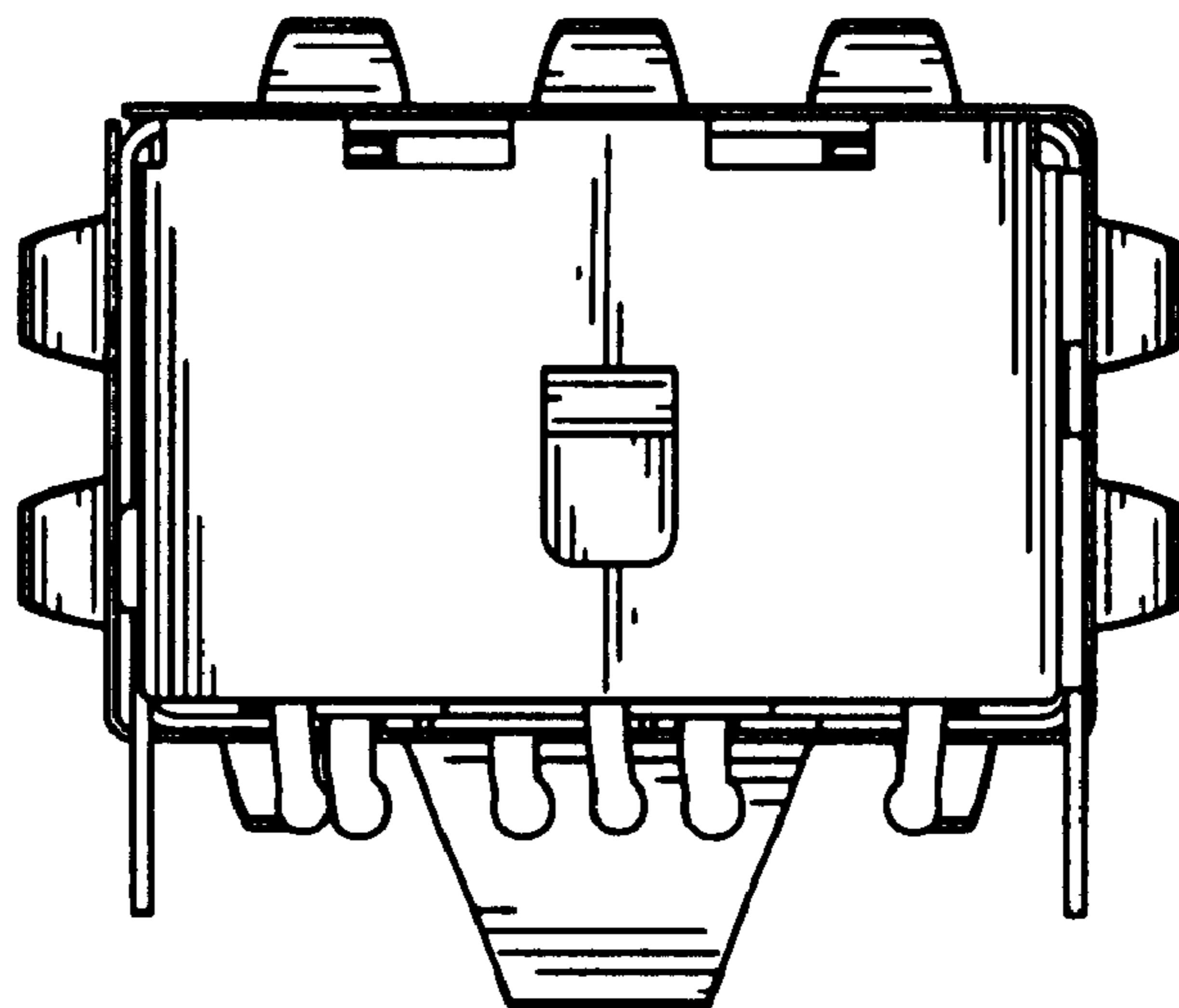


FIG. 3

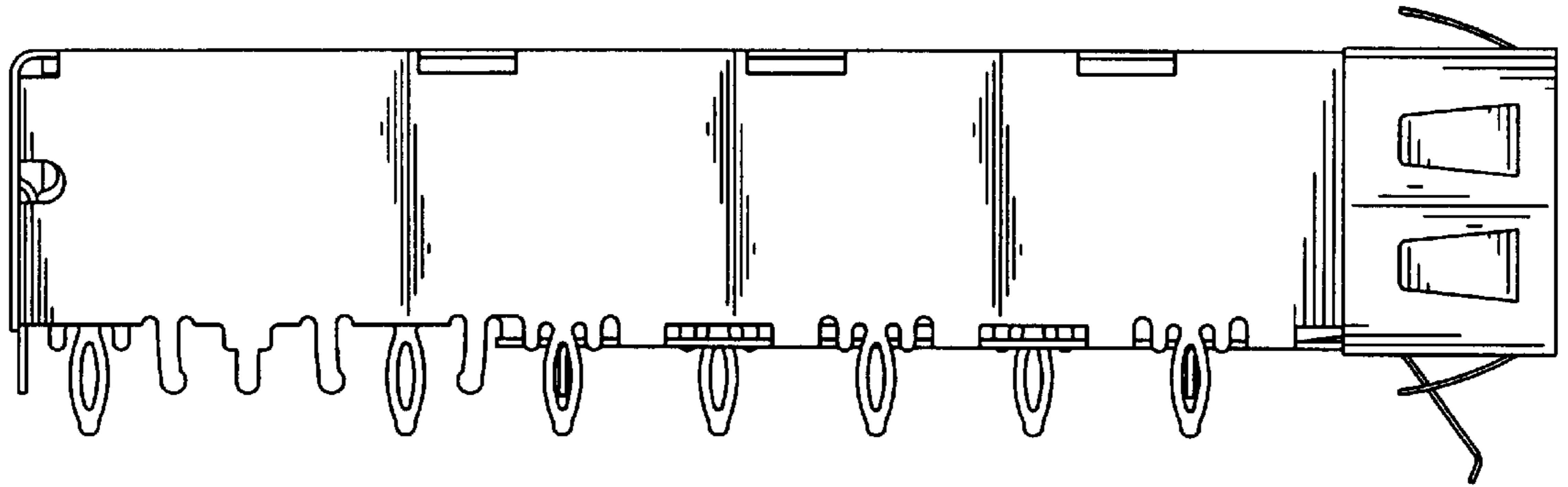


FIG. 4

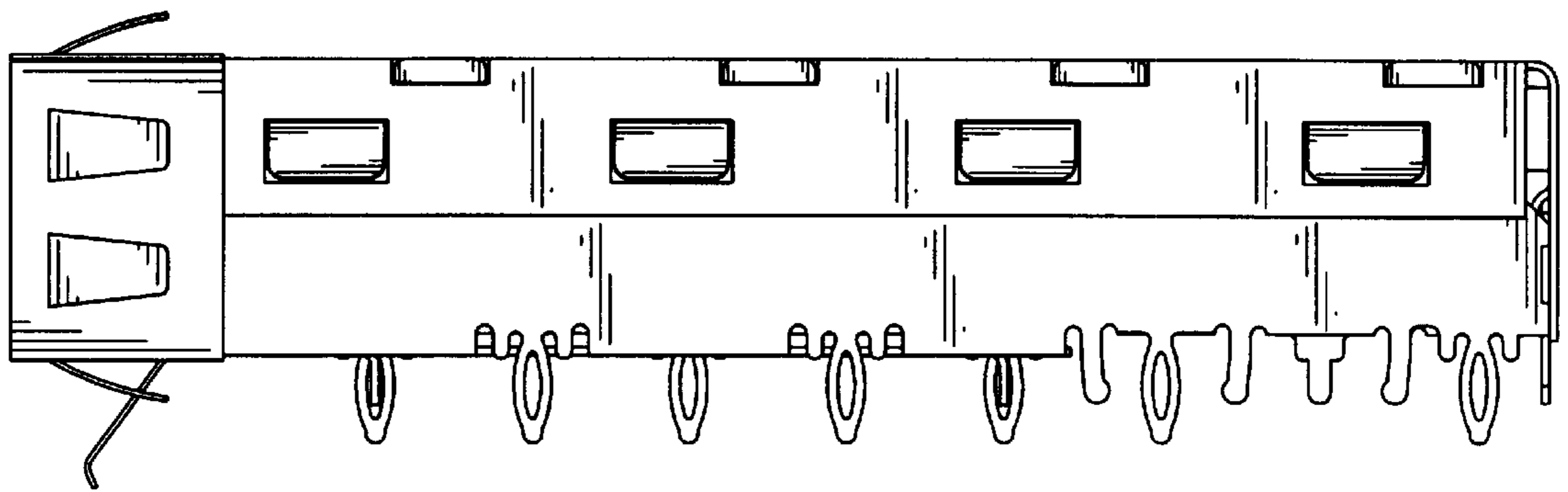


FIG. 5

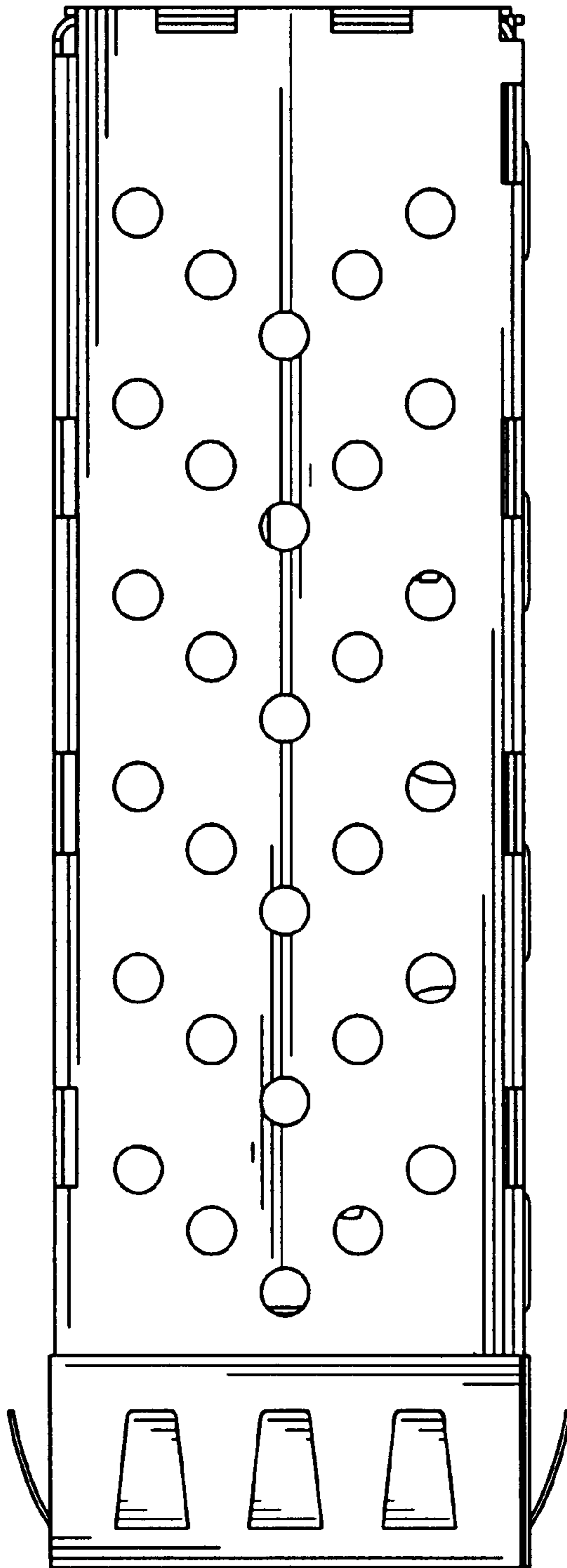


FIG. 6

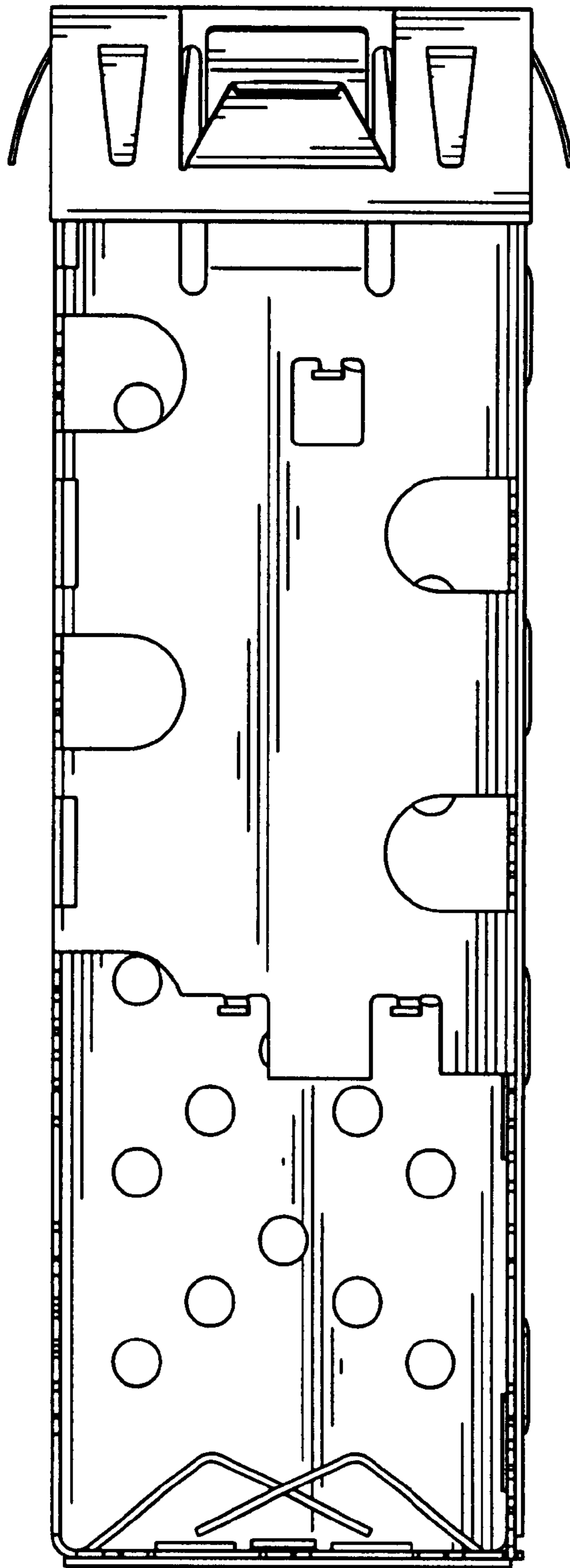


FIG. 7

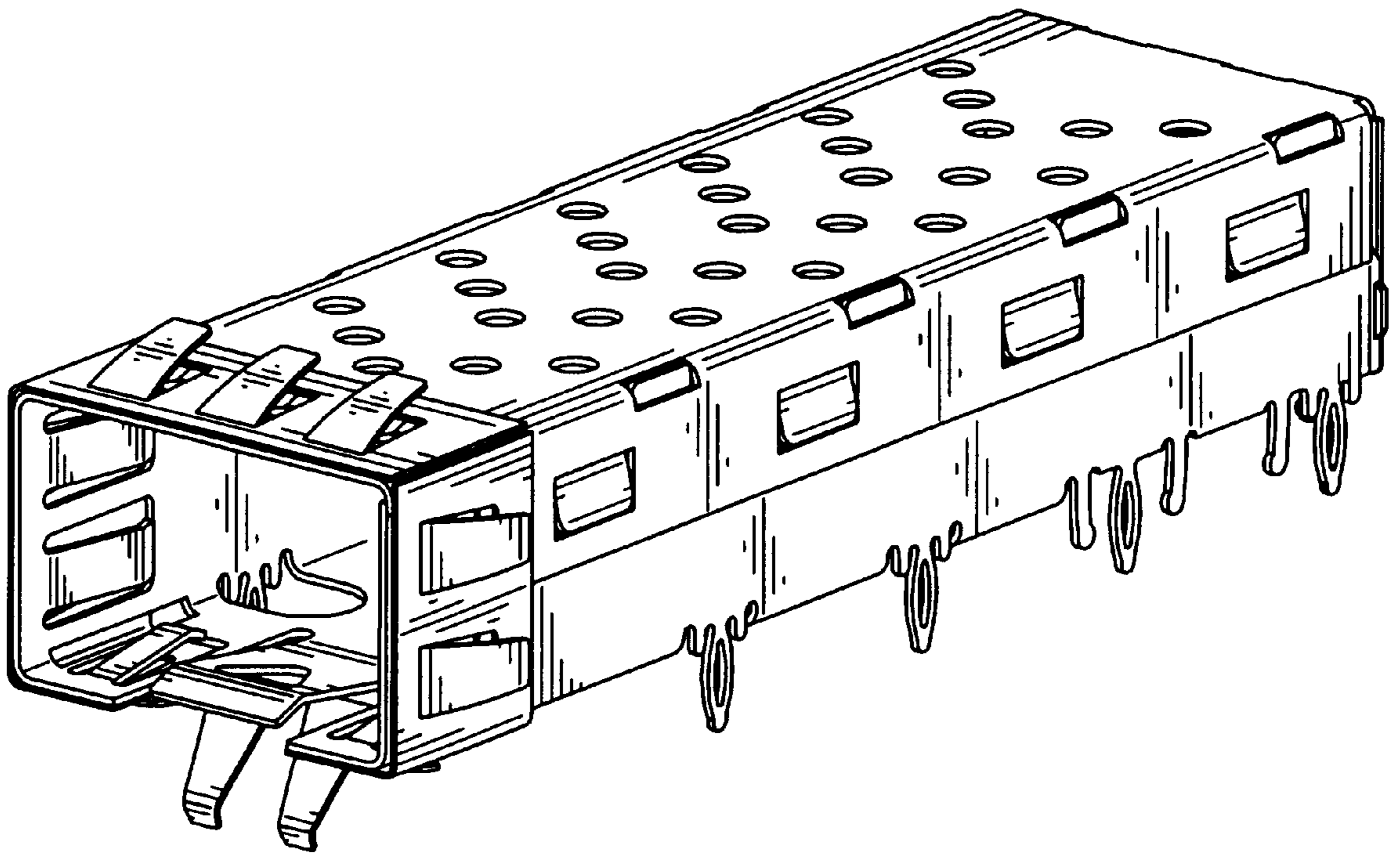


FIG. 8

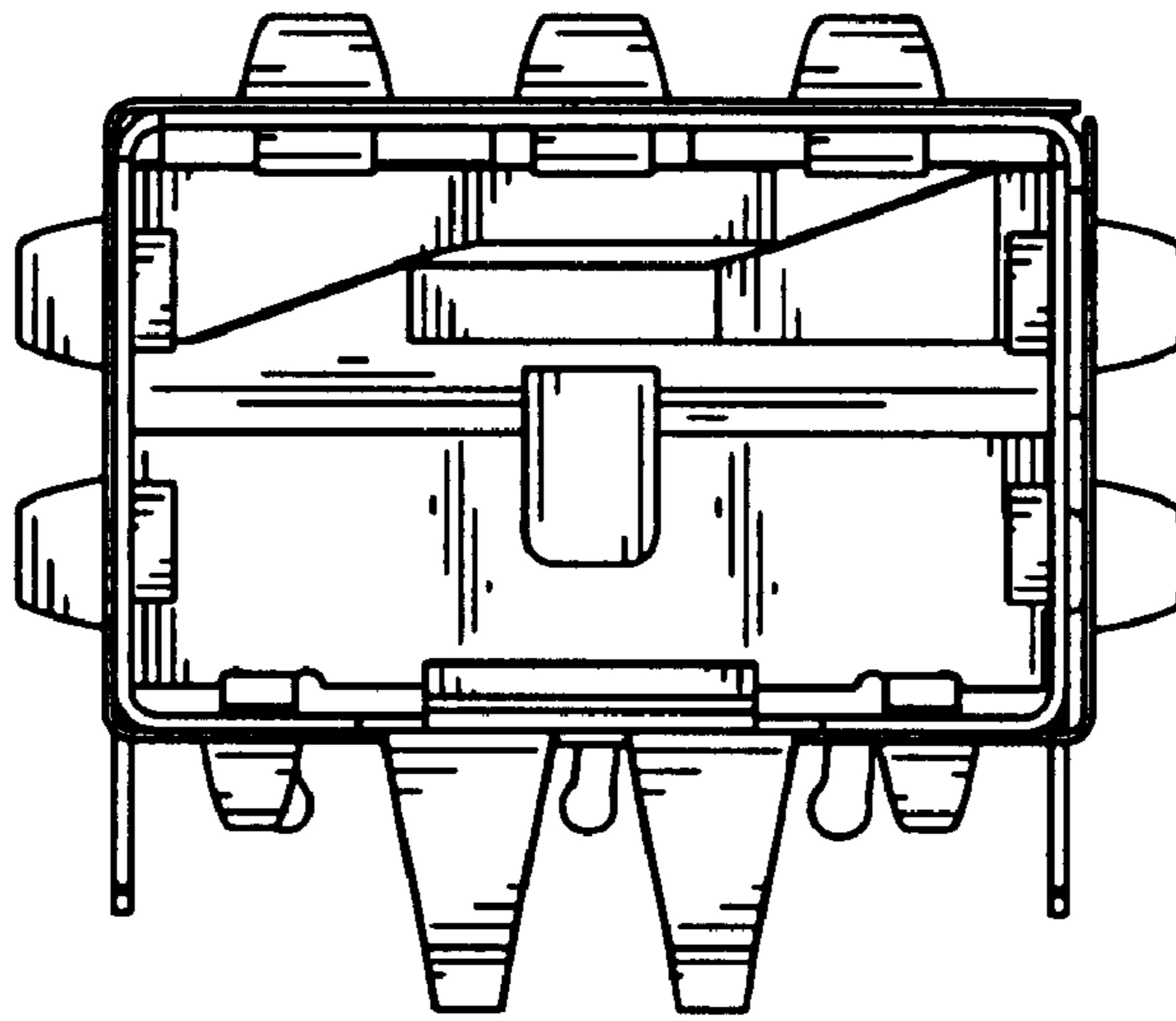


FIG. 9

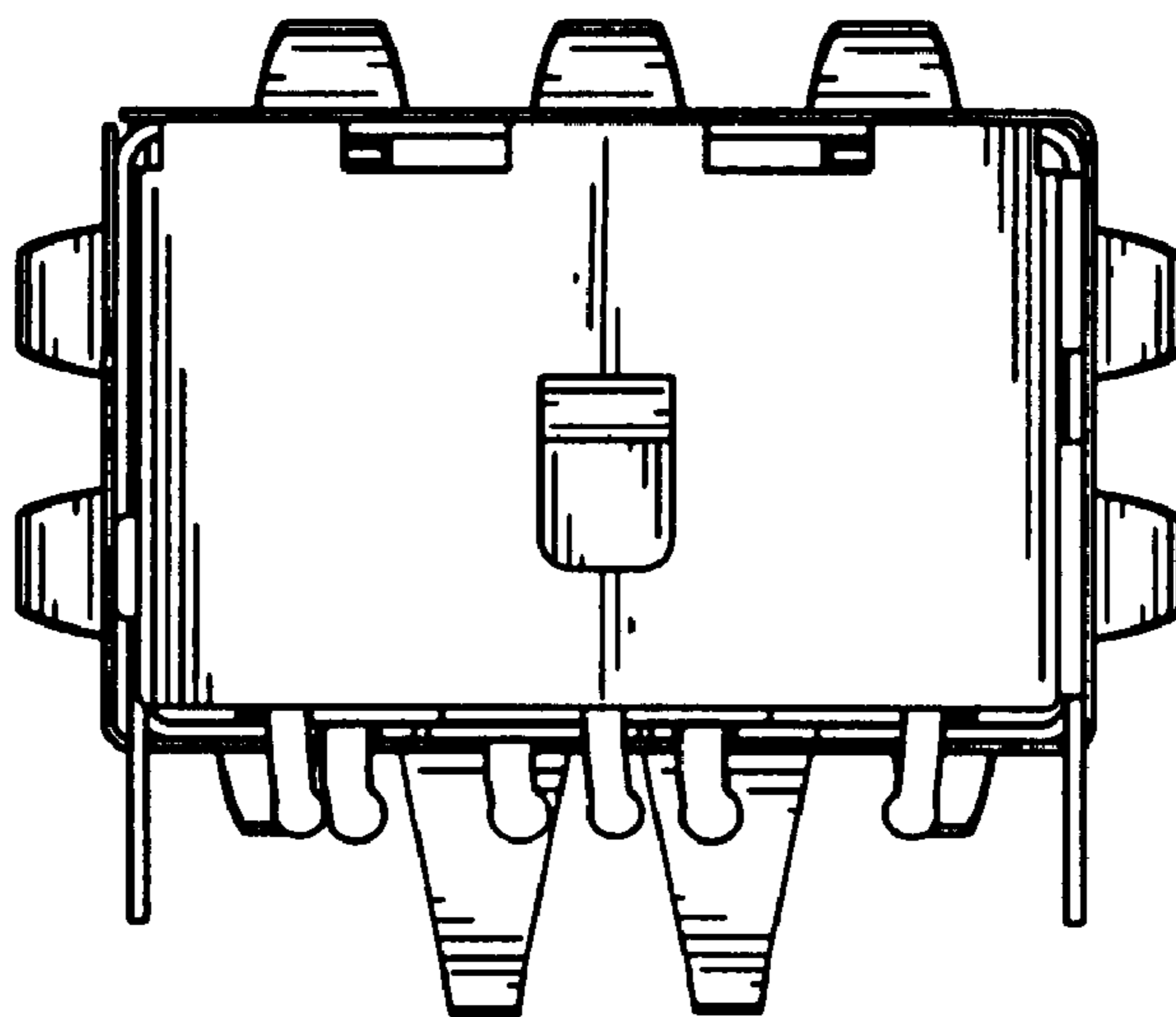


FIG. 10



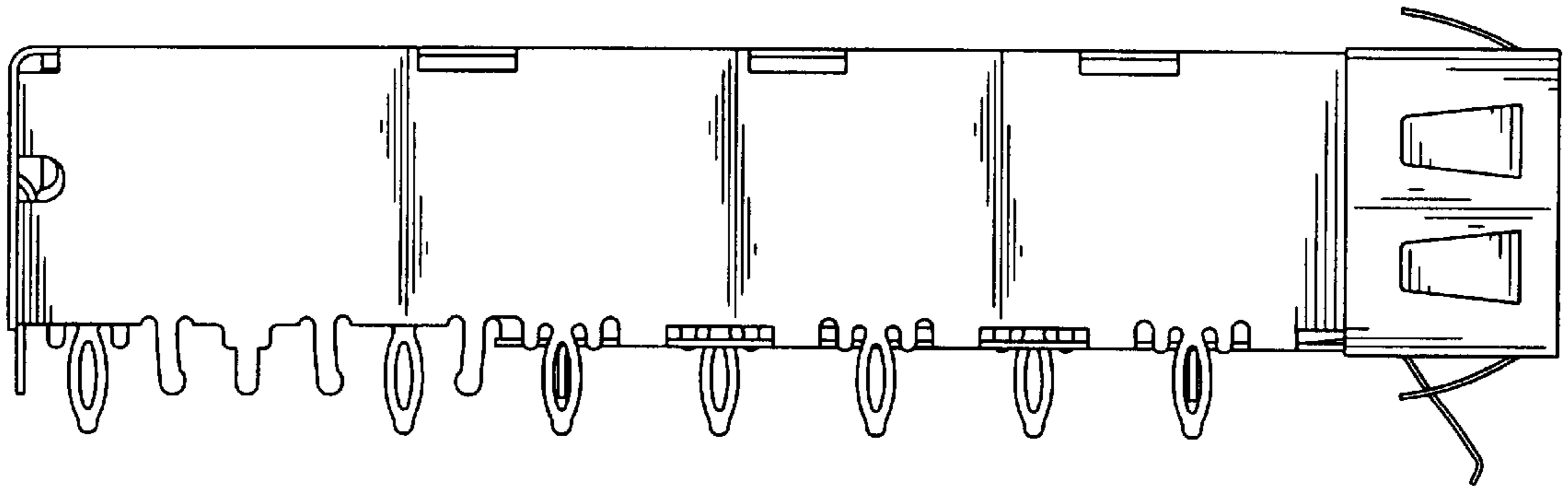


FIG. 11

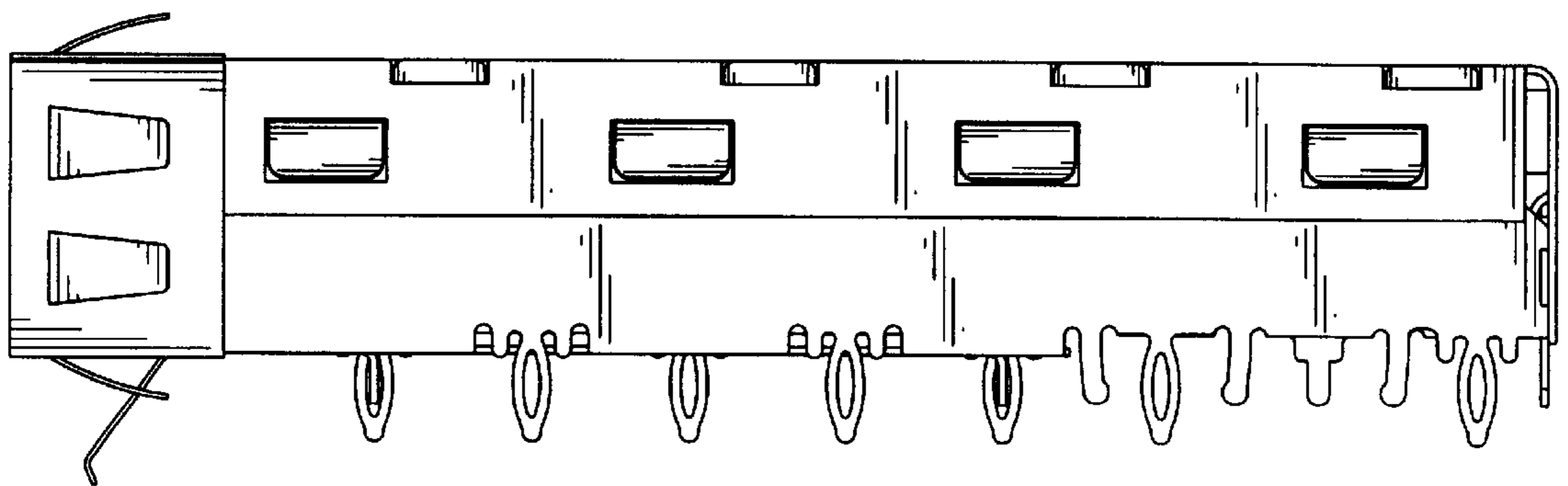


FIG. 12

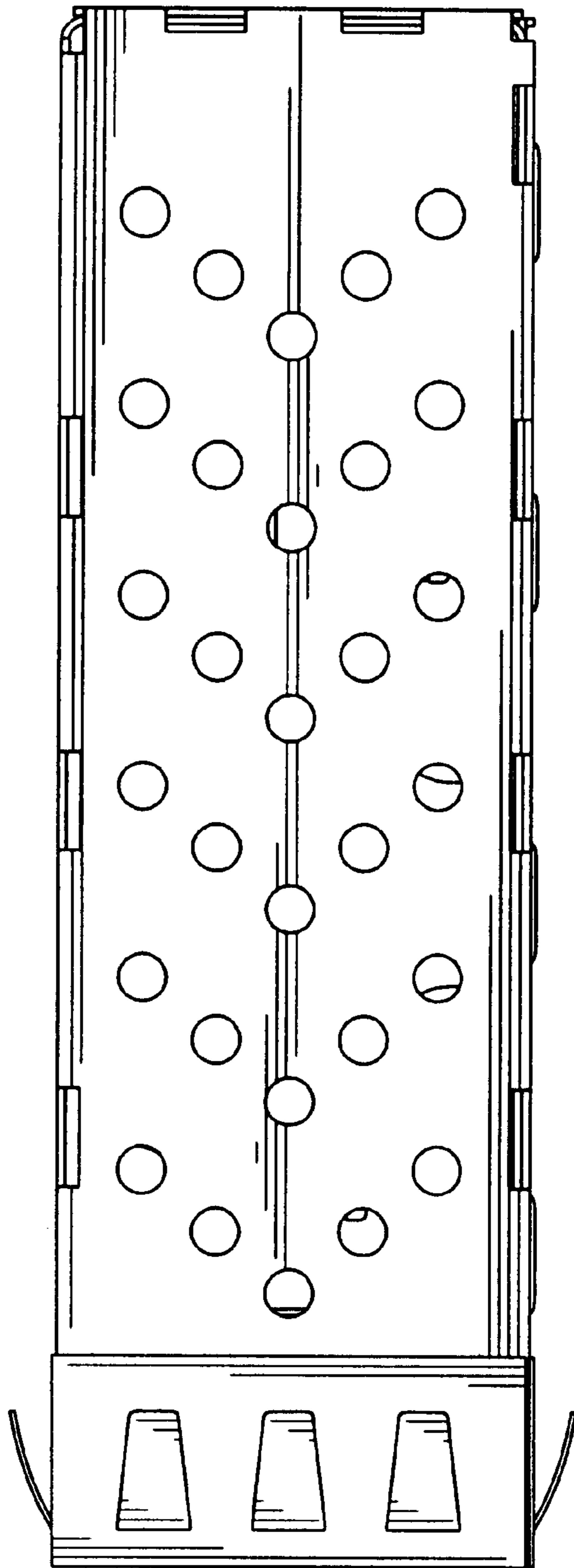


FIG. 13

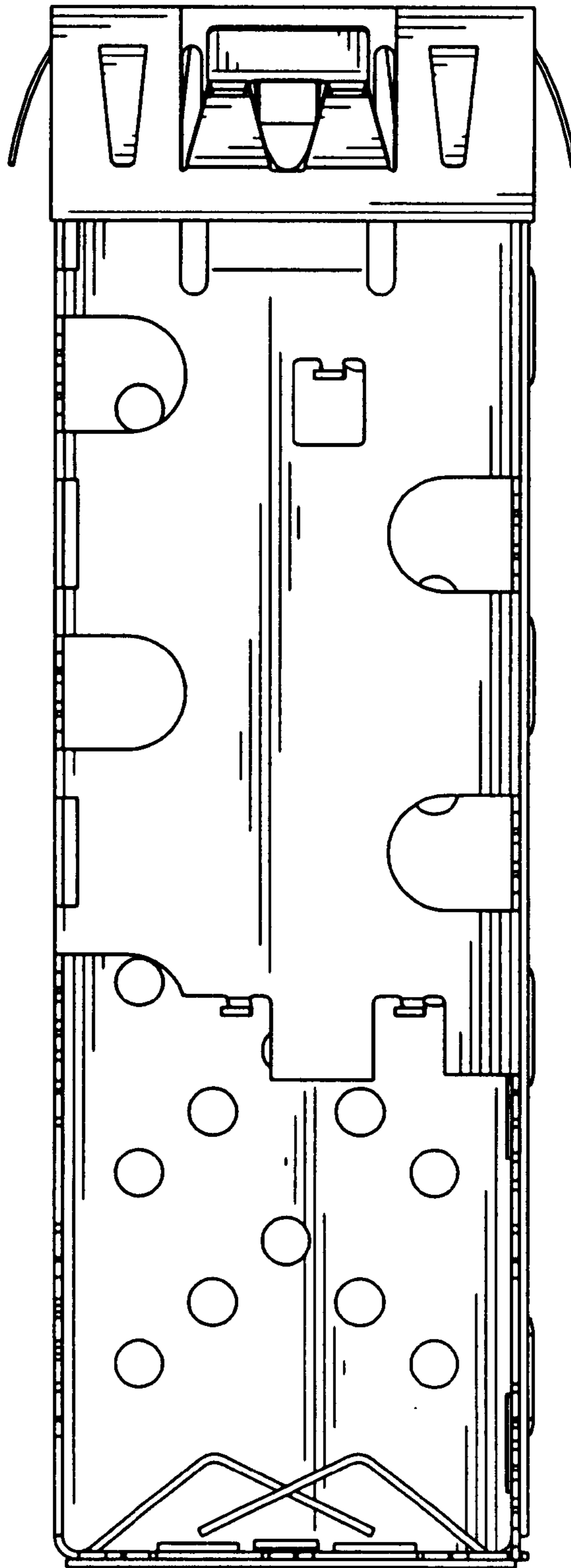


FIG. 14